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Silicon NPN Triple Diffused

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ADE-208-923 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier

Outline

Absolute Maximum Ratings (Ta = 25°C)

ltem	Symbol	Rating	Unit	
Collector to base voltage	V _{CBO}	70	V	
Collector to emitter voltage	V _{CEO}	60	V	
Emitter to base voltage	V _{EBO}	5	V	
Collector current	Ι _c	4	А	
Collector peak current	I _{C(peak)}	8	А	
Collector power dissipation	Pc	2	W	
	P _c * ¹	25		
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note: 1. Value at $T_c = 25^{\circ}C$.

Electrical Characteristics (Ta = 25° C)

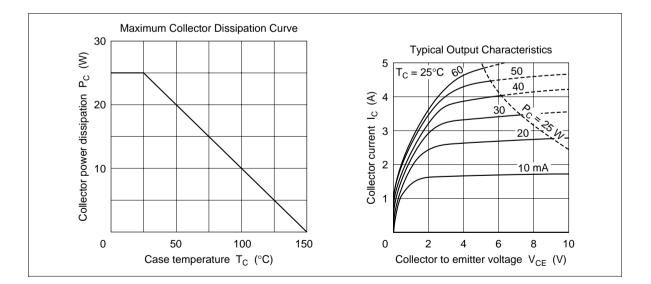
Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	70	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	60	_	_	V	$I_c = 50 \text{ mA}, \text{ R}_{\text{BE}} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	5	_	_	V	$I_{\rm E} = 10 \ \mu A, \ I_{\rm C} = 0$
Collector cutoff current	I _{CBO}			10	μΑ	$V_{CB} = 60 \text{ V}, \text{ I}_{E} = 0$
	I _{CEO}			10		$V_{ce} = 50 \text{ V}, \text{ R}_{be} = \infty$
DC current transfer ratio	$h_{\rm FE1}^{*2}$	60		200		$V_{ce} = 4 V, I_c = 1 A^{*1}$
	h_{FE2}	35				$V_{ce} = 4 \text{ V}, \text{ I}_{c} = 0.1 \text{ A}^{*1}$
Base to emitter voltage	V_{BE}	_		1.0	V	$V_{ce} = 4 \text{ V}, \text{ I}_{c} = 1 \text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.0	V	$I_{\rm c} = 2 \text{ A}, I_{\rm B} = 0.2 \text{ A}^{*1}$
Base to emitter saturation voltage	$V_{\text{BE(sat)}}$	_	_	1.2	V	$I_{\rm C} = 2$ A, $I_{\rm B} = 0.2$ A ^{*1}

Notes: 1. Pulse test.

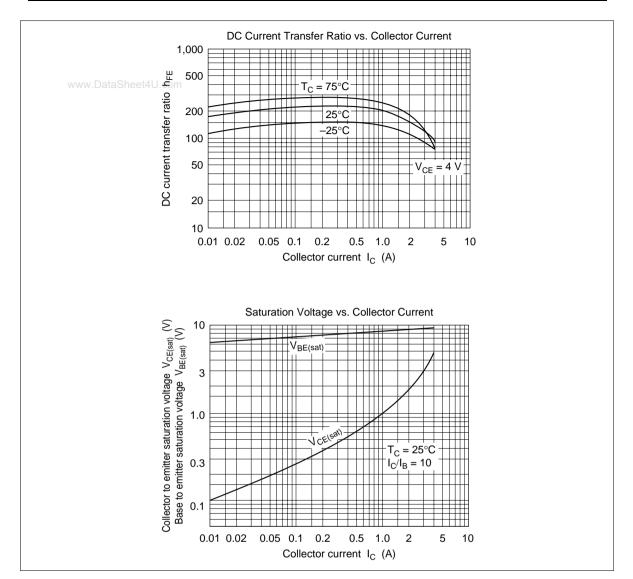
2. The 2SD2107 is grouped by $\rm h_{\rm FE1}$ as follows.

 B
 C

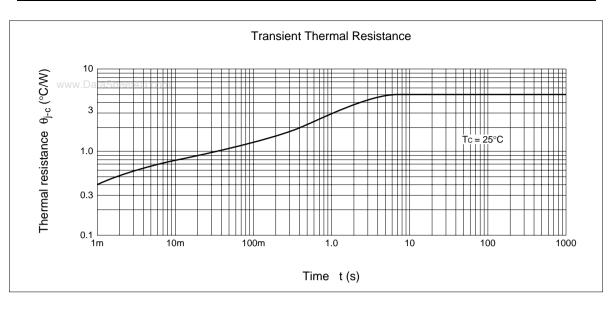
 60 to 120
 100 to 200













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